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April 1st, 2010 Renesas Electronics Corporation

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MOS FIELD EFFECT TRANSISTOR 2SJ604

SWITCHING P-CHANNEL POWER MOS FET

DESCRIPTION

The 2SJ604 is P-channel MOS Field Effect Transistor designed for solenoid, motor and lamp driver.

FEATURES

• Super low on-state resistance:

 $R_{DS(on)1} = 30~m\Omega~MAX.~(V_{GS} = -10~V,~I_{D} = -23~A)$ $R_{DS(on)2} = 43~m\Omega~MAX.~(V_{GS} = -4.0~V,~I_{D} = -23~A)$

• Low input capacitance:

 $C_{iss} = 3300 \text{ pF TYP.} (V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V})$

· Built-in gate protection diode

ORDERING INFORMATION

PART NUMBER	PACKAGE
2SJ604	TO-220AB
2SJ604-S	TO-262
2SJ604-ZJ	TO-263
2SJ604-Z	TO-220SMD Note

Note TO-220SMD package is produced only in Japan

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (Vgs = 0 V)	VDSS	-60	V
Gate to Source Voltage (Vps = 0 V)	Vgss	∓20	V
Drain Current (DC) (Tc = 25°C)	ID(DC)	∓45	Α
Drain Current (pulse) Note1	D(pulse)	∓120	Α
Total Power Dissipation (Tc = 25°C)	Рт	70	W
Total Power Dissipation (T _A = 25°C)	PT	1.5	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
Single Avalanche Current Note2	las	-35	Α
Single Avalanche Energy Note2	Eas	123	mJ

Notes 1. PW \leq 10 μ s, Duty cycle \leq 1%

2. Starting T_{ch} = 25°C, V_{DD} = -30 V, R_G = 25 Ω , V_{GS} = $-20 \rightarrow 0$ V

(TO-220AB)



(TO-262)



(TO-263, TO-220SMD)



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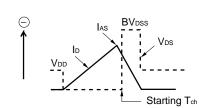


ELECTRICAL CHARACTERISTICS (TA = 25°C)

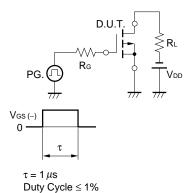
	•	•				
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	Ipss	Vps = -60 V, Vgs = 0 V			-10	μΑ
Gate Leakage Current	lgss	V _G S = ∓20 V, V _D S = 0 V			∓10	μΑ
Gate Cut-off Voltage	V _{GS(off)}	V _{DS} = -10 V, I _D = -1 mA	-1.5	-2.0	-2.5	V
Forward Transfer Admittance	yfs	V _{DS} = -10 V, I _D = -23 A	20	41		S
Drain to Source On-state Resistance	RDS(on)1	V _{GS} = -10 V, I _D = -23 A		23	30	mΩ
	RDS(on)2	Vgs = -4.0 V, Ib = -23 A		30	43	mΩ
Input Capacitance	Ciss	V _{DS} = -10 V		3300		pF
Output Capacitance	Coss	V _{GS} = 0 V		580		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		230		pF
Turn-on Delay Time	td(on)	V _{DD} = -30 V, I _D = -23 A		12		ns
Rise Time	tr	V _{GS} = -10 V		11		ns
Turn-off Delay Time	td(off)	$R_G = 0 \Omega$		77		ns
Fall Time	t f			52		ns
Total Gate Charge	QG	V _{DD} = -48 V		63		nC
Gate to Source Charge	Qgs	V _{GS} = -10 V		11		nC
Gate to Drain Charge	Q _{GD}	I _D = -45 A		16		nC
Body Diode Forward Voltage	VF(S-D)	IF = 45 A, VGS = 0 V		1.0		V
Reverse Recovery Time	trr	IF = 45 A, VGS = 0 V		51		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ μs		105		nC

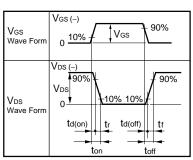
TEST CIRCUIT 1 AVALANCHE CAPABILITY

$\begin{array}{c} \text{D.U.T.} \\ \text{RG} = 25 \ \Omega \\ \text{VGS} = -20 \rightarrow 0 \ \text{V} \\ \end{array}$

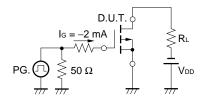


TEST CIRCUIT 2 SWITCHING TIME



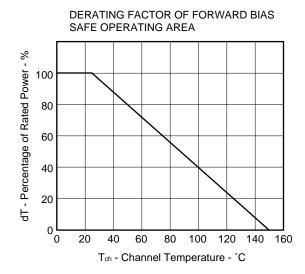


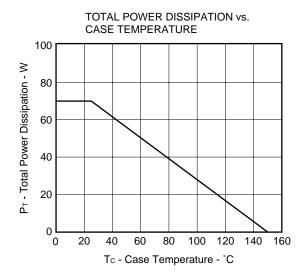
TEST CIRCUIT 3 GATE CHARGE



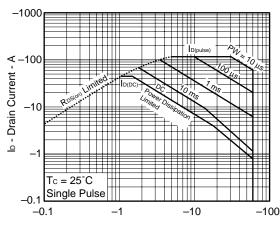


TYPICAL CHARACTERISTICS (TA = 25°C)

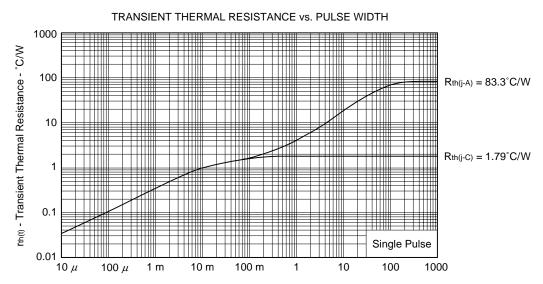




FORWARD BIAS SAFE OPERATING AREA

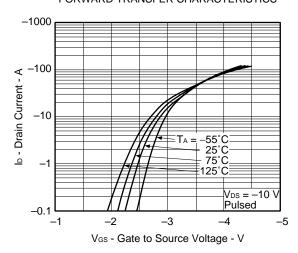


V_{DS} - Drain to Source Voltage - V

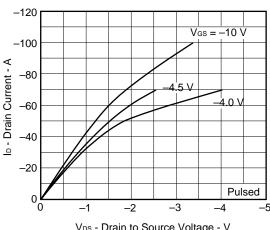


PW - Pulse Width - s Data Sheet D14649EJ3V0DS

FORWARD TRANSFER CHARACTERISTICS

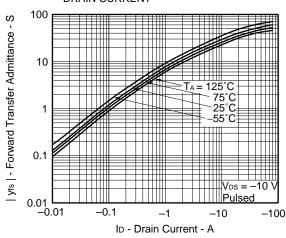


DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE

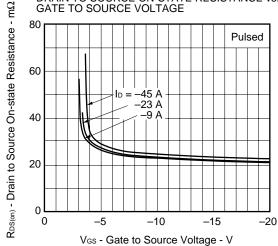


V_{DS} - Drain to Source Voltage - V

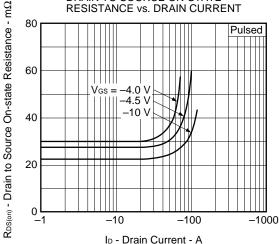
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



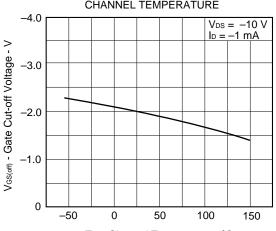
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



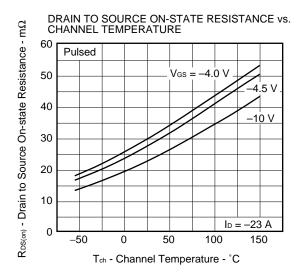
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

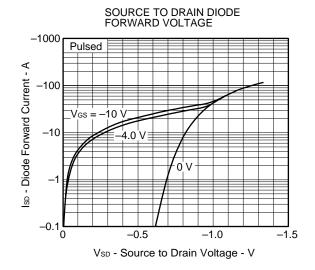


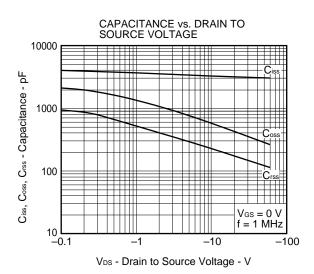
GATE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE

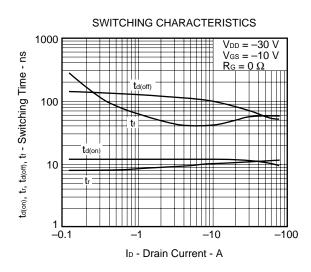


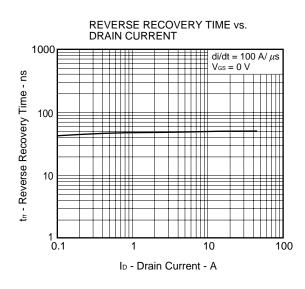
Tch - Channel Temperature - °C

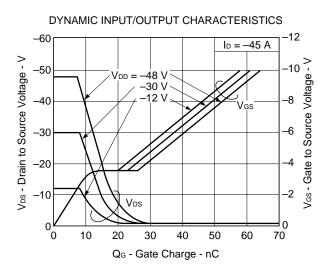




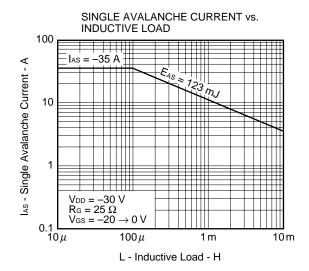


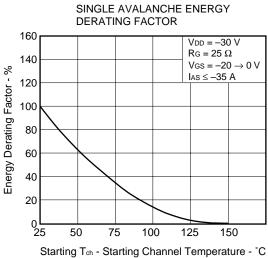






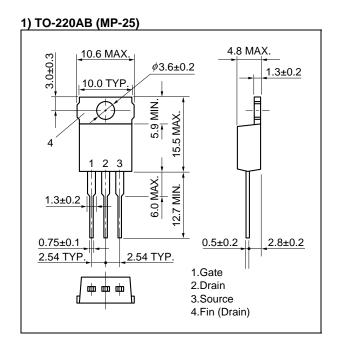
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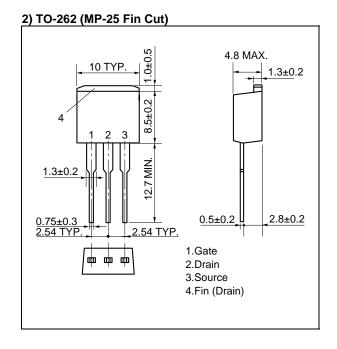


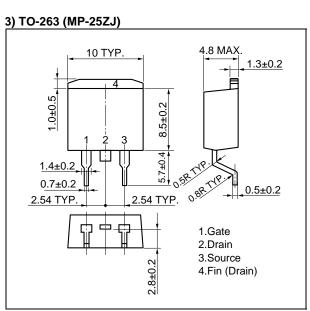


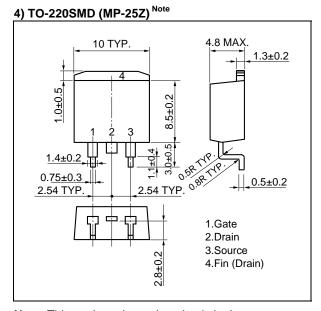


★ PACKAGE DRAWINGS (Unit: mm)



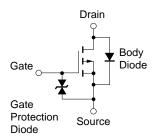






Note This package is produced only in Japan.

EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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